

## DECLARATION

As the below-named inventors, we declare that:

Our residences, post office addresses, and citizenships are as stated below under our names.

We believe we are the original, first, and joint inventors of the subject matter claimed and for which a patent is sought on the invention entitled "FABRICATION OF STACKED MICROELECTRONIC DEVICES" in the foregoing specification and claims.

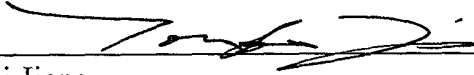
We have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

We acknowledge our duty to disclose information which is material to the patentability of this application in accordance with 37 C.F.R. § 1.56(a).

We further declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that the making of willfully false statements and the like is punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and may jeopardize the validity of any patent issuing from this patent application.

  
Michael ConnellDate 1/7/02

Residence : City of Boise  
State of Idaho  
Citizenship : United States of America  
P.O. Address : 450 Grove Street, #409  
Boise, Idaho 83702

  
\_\_\_\_\_  
Tongbi JiangDate 11/7/02Residence : City of Boise  
State of Idaho

Citizenship : United States of America

P.O. Address : 12036 W. Patrina Dr.  
Boise, Idaho 83713

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: )  
 )  
Michael Connell ) Docket No.: 108298638US  
Tongbi Jiang ) Disclosure Number: 01-0431  
 )  
 )  
Filed: Concurrently herewith )  
 )  
For: FABRICATION OF STACKED )  
MICROELECTRONIC )  
DEVICES )  
 )  
 )  
 )

ASSIGNMENT:

X  Enclosed for recording  
\_\_\_\_ Previously recorded  
Date: \_\_\_\_\_  
Reel: \_\_\_\_\_

FOR GOOD AND VALUABLE CONSIDERATION, the receipt, sufficiency and adequacy of which are hereby acknowledged, the undersigned do hereby:


SELL, ASSIGN AND TRANSFER to **Micron Technology, Inc.** (the "Assignee"), a corporation of Delaware, having a place of business at 8000 South Federal Way, Boise, Idaho 83706-9632, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled **"FABRICATION OF STACKED MICROELECTRONIC DEVICES"**; such application and all divisional, continuing, substitute, renewal, reissue and all other applications for patent which have been or shall be filed in the United States and all foreign countries on any of such improvements; all original and reissued patents which have been or shall be issued in the United States and all foreign countries on such improvements; and specifically including the right to file foreign applications under the provisions of any convention or treaty and claim priority based on such application in the United States of America;

AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign patents granted on such improvements to the Assignee;

WARRANT AND COVENANT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full right to convey the same as herein expressed is possessed by the undersigned;

COVENANT that, when requested and at the expense of the Assignee, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all such improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to the Assignee all facts known to the undersigned relating to such improvements and the history thereof; and generally do everything possible which the Assignee shall consider desirable for securing, maintaining and enforcing proper patent protection for such improvements and for vesting title to such improvements in the Assignee;

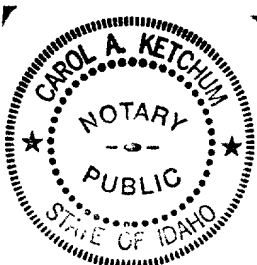
TO BE BINDING on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignee.

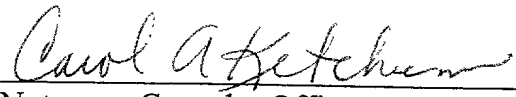
  
Michael Connell Date: 1/7/02

STATE OF IDAHO )  
County of Ada ) ss.

BEFORE ME, this 7th day of January, 2002, personally appeared the above-named individual, to me known to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he executed the same of his own free will for the purpose therein expressed.

SEAL



  
Notary or Consular Officer  
My Commission Expires 05/24/07

Tongbi Jiang  
Tongbi Jiang

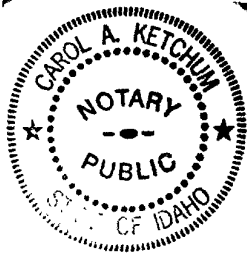
Date: 11/7/02

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County of Ada ) ss.

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SEAL



Carol A. Ketchum  
Notary or Consular Officer  
My Commission Expires 05/24/07